

PROBE CARD

Abstract

Suppresses reflection from a circuit board including a light-transparent insulating film formed on an interlayer wiring to easily identify an alignment mark formed on a probe. The probe card comprises a circuit board 103 on which an insulating film 304 and an electrode pad 3 are formed and a probe 5 attached onto the electrode pad 3. The probe 5 has an alignment mark 7 identifiable from an opposite side of the circuit board 103. The alignment mark 7 is positioned outside of the electrode pad 3 on the circuit board 103. The insulating film 304 is a light-transmissive thin film covering an interlayer wiring 314. An anti-reflection film 6 with lower light transmittance than the insulating film 304 is formed in some regions on the insulating film 304. The anti-reflection film 6 is formed on a position corresponding to the alignment mark 7 and a region surrounding the position.

(FIG. 3)